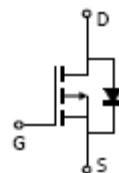


FEATURE

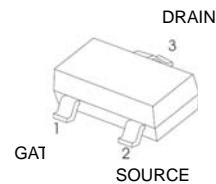
- TrenchFET Power MOSFET

Package**APPLICATIONS**

- Load Switch for Portable Devices
- DC/DC Converter

MARKING

- MARKING: 2301

**SOT-523****Maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	-20	V
Gate-Source Voltage	V _{GS}	±8	
Continuous Drain Current	I _D	-2.0	A
Pulsed Drain Current	I _{DM}	-6	
Continuous Source-Drain Diode Current	I _S	-0.72	
Maximum Power Dissipation	P _D	0.25	W
Thermal Resistance from Junction to Ambient(t≤5s)	R _{θJA}	357	°C/W
Junction Temperature	T _J	150	°C
Storage Temperature	T _{stg}	-55 ~+150	



Electrical characteristics (Ta=25°C unless otherwise noted)

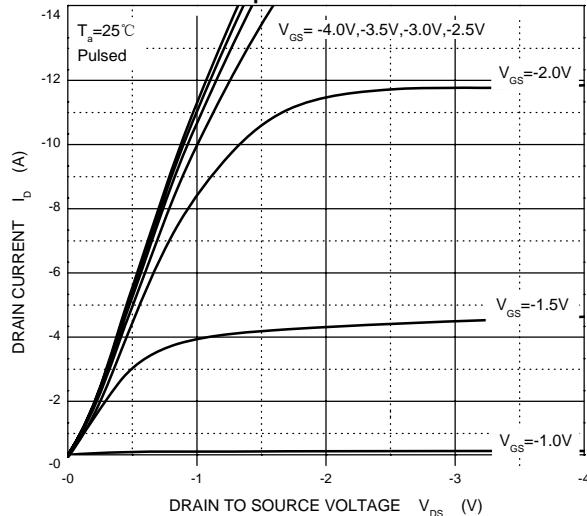
Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Static						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-20			V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-0.4		-1	
Gate-source leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±8V			±100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} = -20V, V _{GS} = 0V			-1	μA
Drain-source on-state resistance ^a	R _{DS(o)}	V _{GS} = -4.5V, I _D = -1.8A		0.125	0.140	Ω
		V _{GS} = -2.5V, I _D = -1.0A		0.135	0.180	
Forward trans conductance ^a	g _{fs}	V _{DS} = -5V, I _D = -2.0A		6.5		S
Dynamic						
Input capacitance	C _{iss}	V _{DS} = -10V, V _{GS} = 0V, f = 1MHz		405		pF
Output capacitance	C _{oss}			75		
Reverse transfer capacitance	C _{rss}			55		
Total gate charge	Q _g	V _{DS} = -10V, V _{GS} = -4.5V, I _D = -3A		5.5	10	nC
Gate-source charge	Q _{gs}	V _{DS} = -10V, V _{GS} = -2.5V, I _D = -3A		3.3	6	
Gate-drain charge	Q _{gd}			0.7		
Gate resistance	R _g			1.3		
Turn-on delay time	t _{d(on)}	V _{DD} = -10V, R _L = 10Ω, I _D = -1A, V _{GEN} = -4.5V, R _g = 1Ω		6.0		Ω
Rise time	t _r			11	20	ns
Turn-off delay time	t _{d(off)}			35	60	
Fall time	t _f			30	50	
				10	20	
Drain-source body diode characteristics						
Continuous source-drain diode current	I _s	T _C = 25°C			-1.3	A
Pulse diode forward current ^a	I _{SM}				-10	
Body diode voltage	V _{SD}	I _s = -0.7A		-0.8	-1.2	V

Notes :

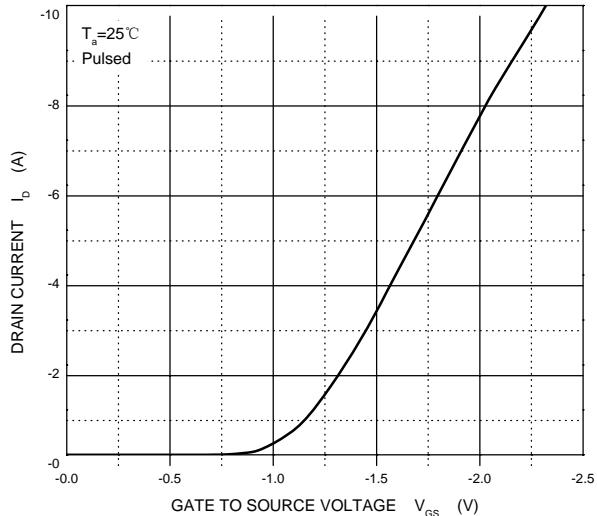
- a.Pulse Test : Pulse Width < 300μs, Duty Cycle ≤2%.
- b.Guaranteed by design, not subject to production testing.

Typical Characteristics

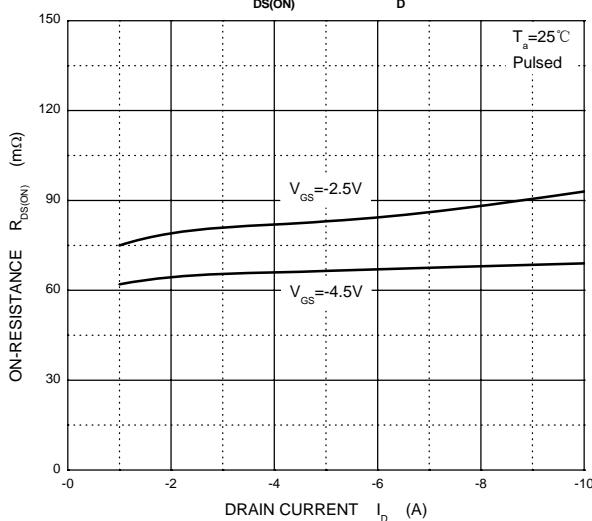
Output Characteristics



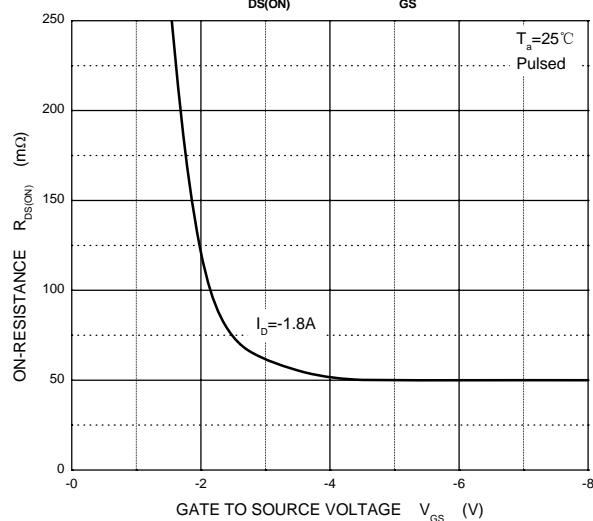
Transfer Characteristics



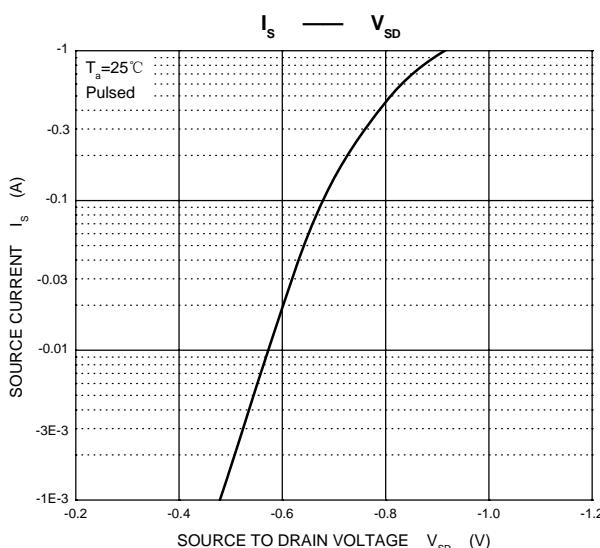
$R_{DS(ON)}$ — I_D



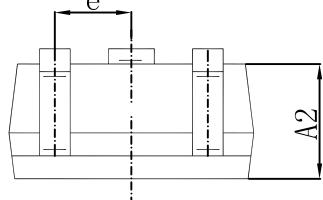
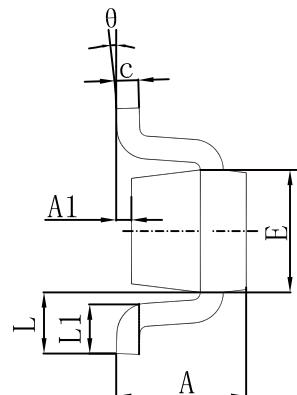
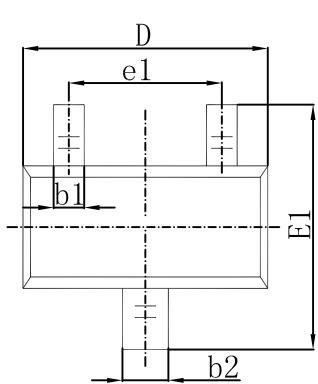
$R_{DS(ON)}$ — V_{GS}



I_S — V_{SD}

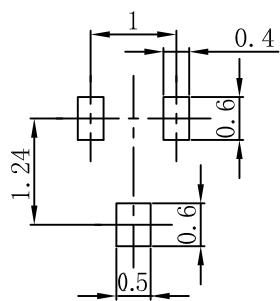


SOT-523 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.700	0.900	0.028	0.035
E1	1.450	1.750	0.057	0.069
e	0.500 TYP.		0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

SOT-523 Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.